02-08-2001 RECC Т **FORM PTO-1595** U.S. DEPARTMENT OF COMMERCE Patent and Trademark Office (Rev. 6-93) 101608577 OMB No. 0651-0011 (exp. 4/94) Tab settings ⇒⇒⇒ To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof. 2. Name and address of receiving party(ies) 1. Name of conveying party(ies): Name: Siemens Aktiengesellschaft 1) Jenoe Tihanyi Internal Address; ZT GG VE 2.2.01 (Additional name(s) of conveying party(ies) attached) M es ⊠No 3. Nature of conveyance: Street Address: Postfach 22 16 34 □ Merger □ Security Agreement □ Change of Name City: München State: Germany ZIP: 80506 □ Other Execution Date: October 25, 2000 Additional name(s) & address(es) attached □Yes ☑No 4. Application number(s) or patent number(s): If this document is being filed together with a new application, the execution date of the application is: A. Patent Application No.(s) B. Patent No.(s 09/688,466 02/b7/2001 GTDN11 00000090 09688466 40.00/ OP 01 FC:581 Additional numbers attached ☐ Yes ☑No 5. Name and address of party to whom 6. Total number of applications and patents involved: correspondence concerning document should be mailed: Name: Lerner and Greenberg 7. Total fee (37 CFR 3.41) ......\$ 40.00 Internal Address: ☐ Authorized to be charged to deposit account 8. Deposit account number: Street Address: P.O. Box 2480 ZIP: 33022 City: Hollywood State: FL (Attach duplicate copy of this page by deposit account) DO NOT USE THIS SPACE 9. Statement and signature. To the best of my knowledge and belief, the foregoing information true and correct and any attached copy is a true copy of the original document. RALPH E. LOCHER REG. NO. 41,947 Name of Person Signing Signature Total number of pages including cover sheet, attachments, and document: Mail documents to be recorded with required cover sheet information to: Commissioner of Patents & Trademarks, Box Assignments

Washington, D.C. 20231

No.8209 P. 21 .16. 2000 9:26AM

Docket No.: GR 98 P 1516

## ASSIGNMENT

WHEREAS I, JENOE TIHANYI, residing at KIRCHHEIM, Germany, have Invented certain new and useful improvements in a

## METHOD FOR FABRICATING AN SOI WAFER FOR LOW-IMPEDANCE HIGH-VOLTAGE SEMICONDUCTOR COMPONENTS

for which an application for Letters Patent of the United States of America was executed on the date of execution of this assignment;

WHEREAS, SIEMENS AKTIENGESELLSCHAFT, a German corporation doing business at München, Germany is desirous of acquiring the entire interest in the invention, and in any and all Letters Patent of the United States that may be obtained therefor:

NOW, THEREFORE, be it known that for and in consideration of my employment by the said corporation and other valuable consideration, the receipt and sufficiency whereof are hereby acknowledged, I have sold, assigned and transferred, and by these presents do sell, assign and transfer unto the said corporation, its legal representative, successors and assigns, the full and exclusive right to the said invention as fully set forth and described in the above-mentioned application, and to the application and any and all divisions and continuations thereof, and any and all Letters Patent of the United States which may be granted therefore, and any and all reissues of the Letters Patent, the same to be held and enjoyed by the said corporation, its legal representatives, successors and assigns, to the full end of the term for which the Letters Patent may be granted or may be reissued or extended, as fully and entirely as the same would have been held by me had this assignment and sale not been made.

AND I hereby authorize the Commissioner of Patents to issue any and all Letters Patent of the United States on the invention or resulting from the application and from any and all divisions and continuations thereof of the sald corporation as the assignee of the entire right, title and interest in and to the same.

IN TESTIMONY WHEREOF, I have hereunto set my hand and seal this 25 10 , 2000. day of

RECORDED: 02/02/2001

**PATENT** 

REEL: 011493 FRAME: 0050